

U413-VB Datasheet

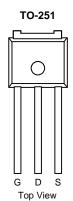
P-Channel 40 V (D-S) MOSFET

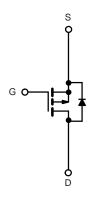
PRODUC	T SUMMARY	
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a
- 40	0.010 at V _{GS} = - 10 V	± 55
- 40	0.014 at V _{GS} = - 4.5 V	± 54

FEATURES

Compliant to RoHS Directive 2002/95/EC







P-Channel MOSFET

ABSOLUTE MAXIMUM RAT	INGS (T _C = 25 °C, unless of	otherwise noted)		
Parameter		Symbol	Limit	Unit
Gate-Source Voltage		V _{GS}	± 40	V
Continuous Droin Current (T 175 °C)	T _C = 25 °C		- 55 ^a	
Continuous Drain Current (T _J = 175 °C)	T _C = 125 °C	I _D	- 52	•
Pulsed Drain Current	I _{DM}	- 220	— A	
Avalanche Current		I _{AR}	- 60	
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	180	mJ
Power Dissinction	T _C = 25 °C	Р	45	W
Power Dissipation	T _A = 25 °C	– P _D –	3.75	vv
Operating Junction and Storage Tempera	ture Range	T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANC	E RATINGS			
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) ^c	D	40	
Junction-to-Ambient	Free Air (TO-220AB)	– R _{thJA}	62.5	°C/W
Junction-to-Case		R _{thJC}	0.8	

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. When mounted on 1" square PCB (FR-4 material).

d. See SOA curve for voltage derating.

* Pb containing terminations are not RoHS compliant, exemptions may apply.



SPECIFICATIONS ($T_J = 25$	°C, unless o	otherwise noted)					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		· · · · · ·					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = -250 \mu A$	- 40			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 2.5	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	μA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 40 V, V _{GS} = 0 V, T _J = 125 °C			- 50		
		V _{DS} = - 40 V, V _{GS} = 0 V, T _J = 175 °C			- 250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -10 V$	- 120			А	
		V _{GS} = - 10 V, I _D = - 30 A		0.010			
Drain-Source On-State Resistance ^a		V _{GS} = - 10 V, I _D = - 30 A, T _J = 125 °C		0.016			
Drain-Source On-State Resistance-	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 30 A, T _J = 175 °C		0.023		52	
		V _{GS} = - 4.5 V, I _D = - 20 A		0.014		Ω S pF	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 75 A	20			S	
Dynamic ^b	•	•		•			
Input Capacitance	C _{iss}			3000		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 25 V, f = 1 MHz		620			
Reversen Transfer Capacitance	C _{rss}			315			
Total Gate Charge ^c	Qg			160			
Gate-Source Charge ^c	Q _{gs}	V_{DS} = - 15 V, V_{GS} = - 10 V, I_{D} = - 75 A		32		nC	
Gate-Drain Charge ^c	Q _{gd}			30			
Turn-On Delay Time ^c	t _{d(on)}			25	40		
Rise Time ^c	tr	V _{DD} = - 15 V, R _I = 0.2 Ω		225	360	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 75 Å, V_{GEN} = - 10 V, R_g = 2.5 Ω		150	240		
Fall Time ^c	t _f			210	340		
Source-Drain Diode Ratings and Cha	racteristics ^b	(T _C = 25 °C)		•			
Continuous Current	ا _S			- 220		•	
Pulsed Current	I _{SM}				- 240	A	
Forward Voltage ^a	V _{SD}	I _F = - 75 A, V _{GS} = 0 V		- 1.2	- 1.5	V	
Reverse Recovery Time	t _{rr}			55	100	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 75 A, dl/dt = 100 A/μs		2.5	5	А	
Reverse Recovery Charge	Q _{rr}	1		0.07	0.25	μC	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

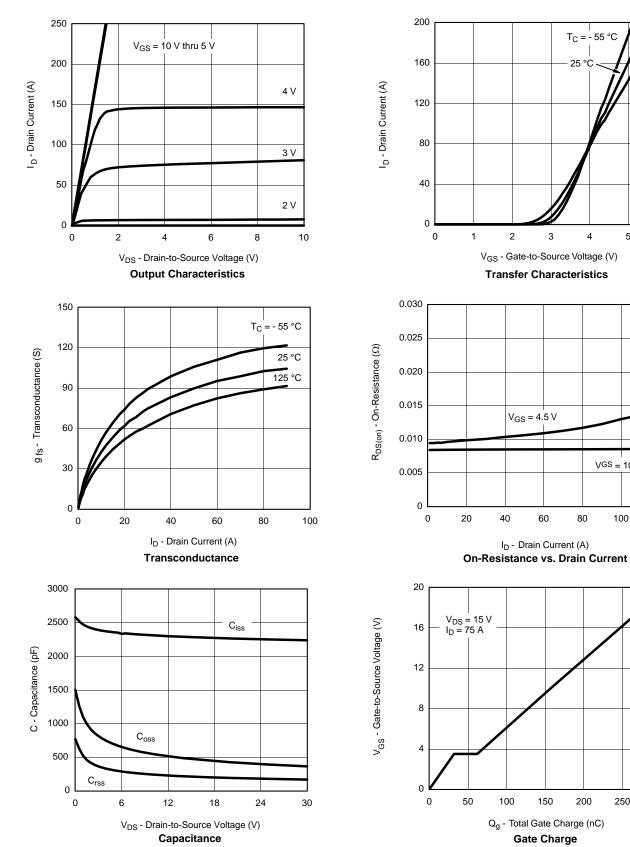
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



125 °C

VGS = 10 V

25 °C



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

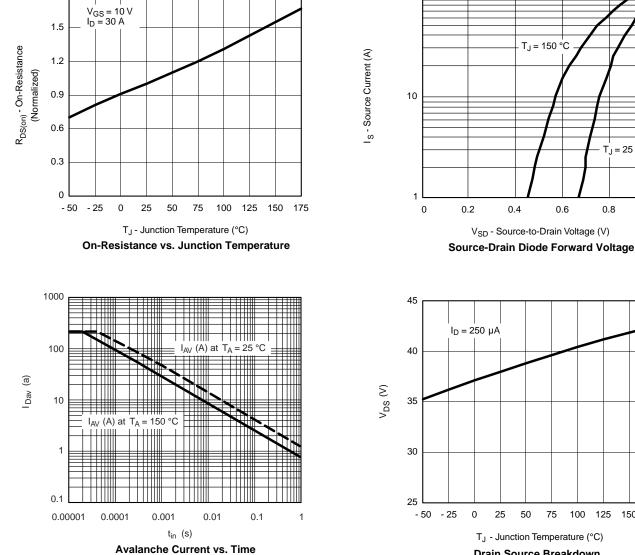
1.8



T_J = 25 °C

1.0

0.8



100

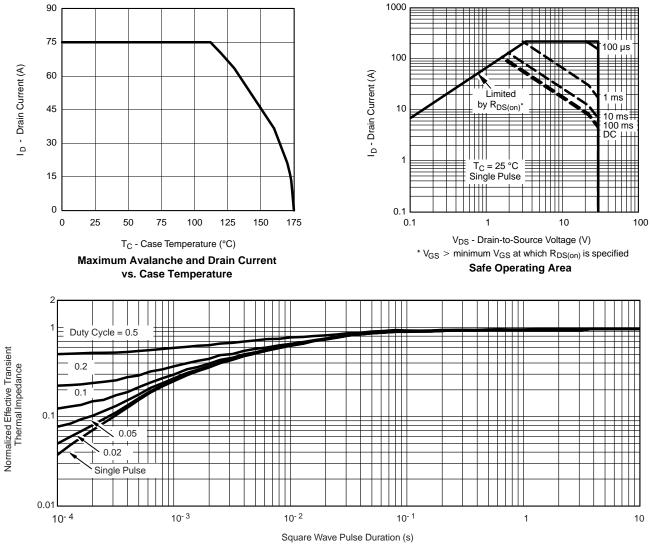
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Drain Source Breakdown vs. Junction Temperature

100 125 150 175



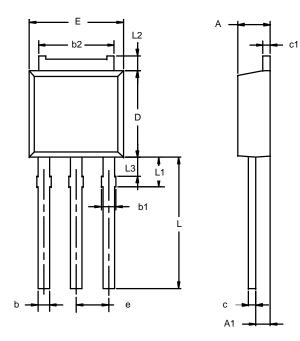
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-251AA (DPAK)



Note: Dimension L3 is for reference only.

	MILLIN	IETERS	INCHES		
Dim	Min	Мах	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28	BSC	0.090 BSC		
L	8.89	9.53	0.350	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	
	3946—Rev. E		0.045	0.060	



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